

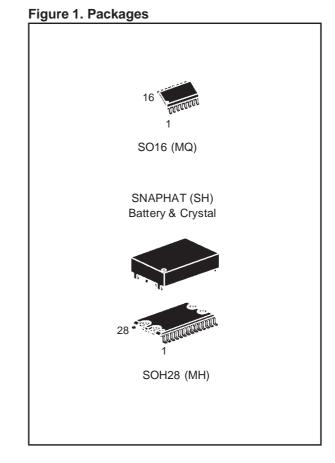
# M41T94

# 512 bit (64 bit x 8) Serial RTC (SPI) SRAM

## PRELIMINARY DATA

## FEATURES SUMMARY

- 2.7 TO 5.5V OPERATING VOLTAGE
- SERIAL PERIPHERAL INTERFACE (SPI)
- 2.5 TO 5.5V OSCILLATOR OPERATING VOLTAGE
- AUTOMATIC SWITCH-OVER and DESELECT CIRCUITRY
- CHOICE of POWER-FAIL DESELECT VOLTAGES:
  - THS = V\_{SS}; V\_{PFD} = 2.65  $\pm$  0.05V
  - THS = V<sub>CC</sub>; V<sub>PFD</sub> = 4.40  $\pm$  0.10V
- COUNTERS for TENTHS/HUNDREDTHS of SECONDS, SECONDS, MINUTES, HOURS, DAY, DATE, MONTH, YEAR and CENTURY
- 44 BYTES of GENERAL PURPOSE RAM
- PROGRAMMABLE ALARM and INTERRUPT FUNCTION (VALID EVEN DURING BATTERY BACK-UP MODE)
- WATCHDOG TIMER
- MICROPROCESSOR POWER-ON RESET
- BATTERY LOW FLAG
- LOW OPERATING CURRENT of 2.0mA
- ULTRA-LOW BATTERY SUPPLY CURRENT OF 500nA (MAX)
- PACKAGING INCLUDES A 28-LEAD SOIC AND SNAPHAT TOP (to be ordered separately) or 16-LEAD SOIC
- 28-LEAD SOIC PACKAGE PROVIDES DIRECT CONNECTION for a SNAPHAT TOP WHICH CONTAINS THE BATTERY and CRYSTAL



January 2001

This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice.

# M41T94

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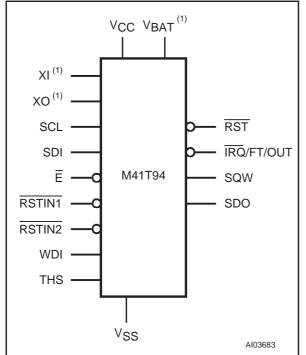


## SUMMARY DESCRIPTION

The M41T94 Serial TIMEKEEPER SRAM is a low power 512 bit static CMOS SRAM organized as 64 words by 8 bits. A built-in 32.768 kHz oscillator (external crystal controlled) and 8 bytes of the SRAM (see Table 12) are used for the clock/calendar function and are configured in binary coded decimal (BCD) format.

An additional 12 bytes of RAM provide status/control of Alarm, Watchdog and Square Wave functions. Addresses and data are transferred serially via a serial SPI interface. The built-in address register is incremented automatically after each write or read data byte. The M41T94 has a built-in power sense circuit which detects power failures and automatically switches to the battery supply when a power failure occurs. The energy needed to sustain the SRAM and clock operations can be supplied by a small lithium button-cell supply when a power failure occurs. Functions available to the user include a non-volatile, time-of-day clock/calendar, Alarm interrupts, Watchdog Timer and programmable Square Wave output. Other features include a Power-On Reset as well as two additional debounced inputs (RSTIN1 and RSTIN2) which can also generate an output Reset (RST). The eight clock address locations contain the century, year, month, date, day, hour, minute, second and tenths/hundredths of a second in 24 hour BCD format. Corrections for 28, 29 (leap year - valid until

#### Figure 2. Logic Diagram



Note: 1. For SO16 package only.

year 2100), 30 and 31 day months are made automatically. The ninth clock address location controls user access to the clock information and also stores the clock software calibration setting.

The M41T94 is supplied in either a 16 lead plastic SOIC (requiring user supplied crystal and battery) or a 28 lead SOIC SNAPHAT package (which integrates both crystal and battery in a single SNAPHAT top). The 28 pin 330mil SOIC provides sockets with gold plated contacts at both ends for direct connection to a separate SNAPHAT housing containing the battery and crystal. The unique design allows the SNAPHAT battery/crystal package to be mounted on top of the SOIC package after the completion of the surface mount process.

Insertion of the SNAPHAT housing after reflow prevents potential battery and crystal damage due to the high temperatures required for device surface-mounting. The SNAPHAT housing is also keyed to prevent reverse insertion.

The SOIC and battery/crystal packages are shipped separately in plastic anti-static tubes or in Tape & Reel form. For the 28 lead SOIC, the battery/crystal package (i.e. SNAPHAT) part number is M4TXX-BR12SH (see Table 14, page 23).

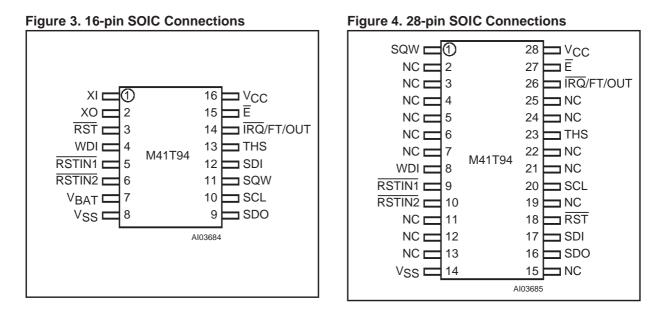
**Caution:** Do not place the SNAPHAT battery/crystal top in conductive foam, as this will drain the lithium button-cell battery.

Ē	Chip Enable
IRQ/FT/OUT	Interrupt/Frequency Test/ Out Output (Open Drain)
RST	Reset Output (Open Drain)
RSTIN1	Reset 1 Input
RSTIN2	Reset 2 Input
SCL	Serial Clock Input
SDI	Serial Data Input
SDO	Serial Data Output
SQW	Square Wave Output
THS	Threshold Select Pin
WDI	Watchdog Input
XI <sup>(1)</sup>	Oscillator Input
XO <sup>(1)</sup>	Oscillator Output
VBAT <sup>(1)</sup>	Battery Supply Voltage
Vcc	Supply Voltage
V <sub>SS</sub>	Ground

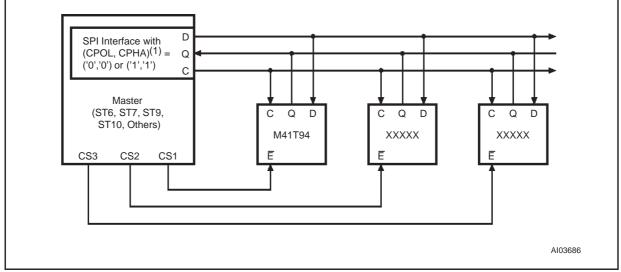
Table 1. Signal Names

Note: 1. For SO16 package only.





## Figure 5. Hardware Hookup



Note: 1. CPOL (Clock Polarity) and CPHA (Clock Phase) are bits that may be set in the SPI Control Register of the MCU.

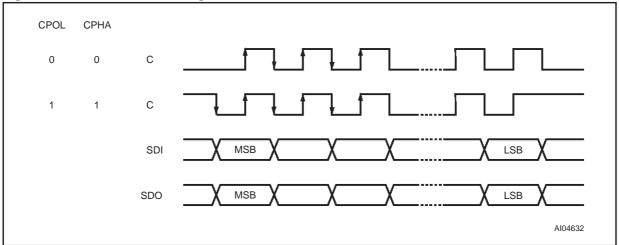
# Table 2. Function Table

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Mode	Ē	SCL	SDI	SDO
Disable Reset	Н	Input Disabled	Input Disabled	High Z
Write	L	L L	Data Bit latch	High Z
Read	L	<b>_</b>	Х	Next data bit shift <sup>(1)</sup>

Note: 1. SDO remains at High Z until eight bits of data are ready to be shifted out during a read.

#### Figure 6. Data and Clock Timing



#### Signal Description

**Serial Data Output (SDO).** The output pin is used to transfer data serially out of the Memory. Data is shifted out on the falling edge of the serial clock.

Serial Data Input (SDI). The input pin is used to transfer data serially into the device. Instructions, addresses, and the data to be written, are each received this way. Input is latched on the rising edge of the serial clock.

**Serial Clock (SCL).** The serial clock provides the timing for the serial interface (as shown in Figure 8, page 11 and Figure 9, page 11). W/R bit, addresses, or data are latched, from the input pin, on the rising edge of the clock input. The output data on the SDO pin changes state after the falling edge of the clock input.

The M41T94 can be driven by a microcontroller with its SPI peripheral running in either of the two following modes:

(CPOL, CPHA) = ('0', '0') or

(CPOL, CPHA) = ('1', '1').

For these two modes, input data (SDI) is latched in by the low-to-high transition of clock SCL, and ouput data (SDO) is shifted out on the high-to-low transition of SCL (see Table 2, page 5 and Figure 6, page 6).

**Chip Enable (\overline{E}).** When  $\overline{E}$  is high, the memory device is deselected, and the SDO output pin is held in its high impedance state.

After power-on, a high-to-low transition on  $\overline{E}$  is required prior to the start of any operation.

#### **MAXIMUM RATING**

Stressing the device above the rating listed in the Absolute Maximum Ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Symbol	Parameter		Value	Unit
lo	Output Current		20	mA
PD	Power Dissipation		1	W
T <sub>SLD</sub> <sup>(2)</sup>	Lead Solder Temperature for 10 seconds		260	°C
T <sub>STG</sub>	Storage Temperature (VCC Off, Oscillator Off)	SNAPHAT	-40 to 85	°C
1816		SOIC	–55 to 125	°C
Vcc	Supply Voltage		-0.3 to 7	V
V <sub>IO</sub>	Input or Output Voltage		–0.3 to V <sub>CC</sub> +0.3	V

**Table 3. Absolute Maximum Ratings** 

Note: 1. Soldering temperature not to exceed 260°C for 10 seconds (total thermal budget not to exceed 150°C for longer than 30 seconds). **CAUTION:** Negative undershoots below –0.3V are not allowed on any pin while in the Battery Back-up mode. **CAUTION:** Do NOT wave solder SOIC to avoid damaging SNAPHAT sockets.



## DC AND AC PARAMETERS

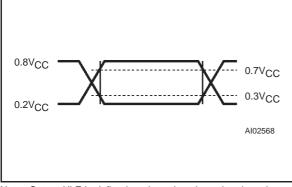
This section summarizes the operating and measurement conditions, as well as the DC and AC characteristics of the device. The parameters in the following DC and AC Characteristic tables are derived from tests performed under the Measurement Conditions listed in the relevant tables. Designers should check that the operating conditions in their projects match the measurement conditions when using the quoted parameters.

#### Table 4. DC and AC Measurement Conditions

Parameter	M41T94
V <sub>CC</sub> Supply Voltage	2.7 to 3.6V
Ambient Operating Temperature	–40 to 85°C
Load Capacitance (CL)	100pF
Input Rise and Fall Times	≤ 50ns
Input Pulse Voltages	0.2 to 0.8V <sub>CC</sub>
Input and Output Timing Ref. Voltages	0.3 to 0.7V <sub>CC</sub>

Note: Output Hi-Z is defined as the point where data is no longer driven.

## Figure 7. AC Testing Input/Output Waveforms



Note: Output Hi-Z is defined as the point where data is no longer driven.

#### **Table 5. Capacitance**

Symbol	Parameter	Тур	Min	Мах	Unit
f <sub>0</sub>	Resonant Frequency	32.768			kHz
Rs	Series Resistance			60	kΩ
CL	Load Capacitance	12.5			pF

Note: Load capacitors are integrated within the M41T94. Circuit board layout considerations for the 32.768 kHz crystal of minimum trace lengths and isolation from RF generating signals should be taken into account. These characteristics are externally supplied.

STMicroelectronics recommends the KDS DT-38 Tuning Fork Type (thru-hole) or DMX-26 (SMD) quartz crystal for industrial temperature operations.

KDS can be contacted at kouhou@kdsj.co.jp or http://www.kdsj.co.jp for further information on this crystal type.



Symb.	Parameter	Test Condition	Min	Тур	Max	Unit
lo	Battery Current OSC ON $T_A = 25^{\circ}C, V_{CC} =$			400	500	nA
IBAT	Battery Current OSC OFF	V <sub>BAT</sub> = 3V		50		nA
ICC1	Supply Current	f = 2MHz			2	mA
I <sub>CC2</sub>	Supply Current (Standby)	SCL, SDA = $V_{CC} - 0.3V$			1.4	mA
I <sub>LI</sub> <sup>(1,2)</sup>	Input Leakage Current	$0V \le V_{IN} \le V_{CC}$			±1	μA
Ilo <sup>(1)</sup>	Output Leakage Current	$0V \le V_{OUT} \le V_{CC}$			±1	μA
VIH	Input High Voltage		0.7Vcc		VCC + 0.3	V
VIL	Input Low Voltage		-0.3		0.3VCC	V
VBAT	Battery Voltage			3.0		V
Voн	Output High Voltage	I <sub>OH</sub> = -1.0mA	2.4			V
Max	Output Low Voltage	I <sub>OL</sub> = 3.0mA			0.4	v
V <sub>OL</sub>	Output Low Voltage (Open Drain) (3)	I <sub>OL</sub> = 10mA			0.4	1
\/	Power Fail Deselect (THS = V <sub>CC</sub> )		4.30	4.40	4.50	v
Vpfd	Power Fail Deselect (THS = $V_{SS}$ )		2.60	2.65	2.70	
$V_{SO}$	Battery Back-up Switchover			2.5		V

## **Table 6. DC Characteristics**

Note: 1. Outputs Deselected.
2. RSTIN1 and RSTIN2 internally pulled-up to V<sub>CC</sub> through 100KΩ resistor. WDI internally pulled-down to V<sub>SS</sub> through 100KΩ resistor.
3. For IRQ/FT/OUT, RST pins (Open Drain).

## OPERATION

The M41T94 clock operates as a slave device on the SPI serial bus. Each memory device is accessed by a simple serial interface that is SPI bus compatible. The bus signals are SCL, SDI and SDO (see Table 1, page 4 and Figure 5, page 5). The device is selected when the Chip Enable input ( $\overline{E}$ ) is held low. All instructions, addresses and data are shifted serially in and out of the chip. The most significant bit is presented first, with the data input (SDI) sampled on the first rising edge of the clock (SCL) after the Chip Enable ( $\overline{E}$ ) goes low. The 64 bytes contained in the device can then be accessed sequentially in the following order:

- 1. Tenths/Hundredths of a Second Register
- 2. Seconds Register
- 3. Minutes Register
- 4. Century/Hours Register
- 5. Day Register
- 6. Date Register
- 7. Month Register
- 8. Year Register
- 9. Control Register
- 10. Watchdog Register
- 11 16.Alarm Registers
- 17 19.Reserved
- 20. Square Wave Register
- 21 64.User RAM

The M41T94 clock continually monitors V<sub>CC</sub> for an out-of tolerance condition. Should V<sub>CC</sub> fall below V<sub>PFD</sub>, the device terminates an access in progress and resets the device address counter. Inputs to the device will not be recognized at this time to prevent erroneous data from being written to the device from a an out-of-tolerance system. When V<sub>CC</sub> falls below V<sub>SO</sub>, the device automatically switches over to the battery and powers down into an ultra low current mode of operation to conserve battery life. As system power returns and V<sub>CC</sub> rises above Vso, the battery is disconnected, and the

power supply is switched to external V<sub>CC</sub>. Write protection continues until V<sub>CC</sub> reaches V<sub>PFD</sub> (max) plus  $t_{REC}$ . For more information on Battery Storage Life refer to Application Note AN1012.

## **SPI Bus Characteristics**

The Serial Peripheral interface (SPI) bus is intended for synchronous communication between different IC's. It consists of four signal lines: Serial Data Input (SDI), Serial Data Output (SDO), Serial Clock (SCL) and a Chip Enable (E).

By definition a device that gives out a message is called 'transmitter,' the receiving device that gets the message is called 'receiver.' The device that controls the message is called 'master'. The devices that are controlled by the master are called 'slaves.'

The  $\overline{E}$  input is used to initiate and terminate a data transfer. The SCL input is used to synchronize data transfer between the master (micro) and the slave (M41T94) devices.

The SCL input, which is generated by the microcontroller, is active only during address and data transfer to any device on the SPI bus (see Figure 5, page 5).

The M41T94 can be driven by a microcontroller with its SPI peripheral running in either of the two following modes:

(CPOL, CPHA) = ('0', '0') or

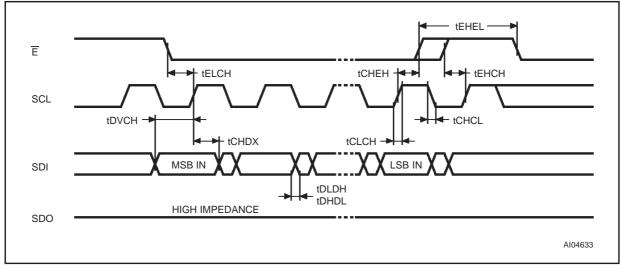
(CPOL, CPHA) = ('1', '1').

For these two modes, input data (SDI) is latched in by the low-to-high transition of clock SCL, and ouput data (SDO) is shifted out on the high-to-low transition of SCL (see Table 2, page 5 and Figure 6, page 6).

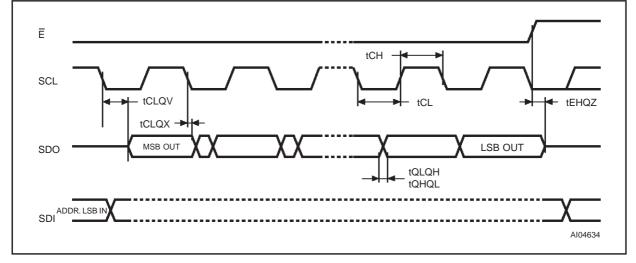
There is one clock for each bit transferred. Address and data bits are transferred in groups of eight bits. Due to memory size the second most significant address bit is a Don't Care (address bit 6).











Symbol	Parameter	Min	Max	Unit
f <sub>SCL</sub>	Serial Clock Input Frequency	DC	2	MHz
t <sub>CH</sub> <sup>(1)</sup>	Clock High	200		ns
t <sub>CHCL</sub> <sup>(2)</sup>	Clock Transition (Fall Time)		1	μs
t <sub>CHDX</sub>	Serial Clock Input High to Input Data Transition	50		ns
t <sub>CHEH</sub>	Serial Clock Input High to Chip Enable High	200		ns
t <sub>CL</sub> <sup>(1)</sup>	Clock Low	200		ns
t <sub>CLCH</sub> <sup>(2)</sup>	Clock Transition (Rise Time)		1	μs
tCLQV	Serial Clock Input Low to Output Valid		150	ns
t <sub>CLQX</sub>	Serial Clock Input Low to Output Data Transition	0		ns
t <sub>DHDL</sub> <sup>(2)</sup>	Input Data Transition (Fall Time)		1	μs
t <sub>DLDH</sub> <sup>(2)</sup>	Input Data Transition (Rise Time)		1	μs
t <sub>DVCH</sub>	Input Data to Serial Clock Input High	40		ns
t <sub>EHCH</sub>	Chip Enable High to Serial Clock Input High	200		ns
t <sub>EHEL</sub>	Chip Enable High to Chip Enable Low	200		ns
t <sub>EHQZ</sub> <sup>(2)</sup>	Chip Enable High to Output High-Z		250	ns
<b>t</b> ELCH	Chip Enable Low to Serial Clock Input High	200		ns
tqhql <sup>(2)</sup>	Output Data Transition (Fall Time)		100	ns
t <sub>QLQH</sub> <sup>(2)</sup>	Output Data Transition (Rise Time)		100	ns

# **Table 7. AC Characteristics**

Note: 1.  $t_{CH} + t_{CL} \ge 1/f_{SCL}$ 2. Value guaranteed by characterization, not 100% tested in production.



#### **Read And Write Cycles**

Address and data are shifted MSB first into the Serial Data Input (SDI) and out of the Serial Data Output (SDO). Any data transfer considers the first bit to define whether a read or write will occur. This is followed by seven bits defining the address to be read or written. Data is transferred out of the SDO for a read operation and into the SDI for a write operation. The address is always the second through the eighth bit written after the Enable ( $\overline{E}$ ) pin goes low. If the first bit is a '1', one or more write cycles will occur. If the first bit is a '0', one or more read cycles will occur (see Figure 8, page 11 and Figure 9, page 11).

Data transfers can occur one byte at a time or in multiple byte burst mode, during which the address pointer will be automatically incremented.

For a single byte transfer, one byte is read or written and then  $\overline{E}$  is driven high. For a multiple byte transfer all that is required is that  $\overline{E}$  continue to remain low. Under this condition, the address pointer will continue to increment as stated previously. Incrementing will continue until the device is deselected by taking  $\overline{E}$  high. The address will wrap to 00h after incrementing to 3Fh.

The system-to-user transfer of clock data will be halted whenever the address being read is a clock address (00h to 07h). Although the clock continues to maintain the correct time, this will prevent updates of time and date during either a read or write of these address locations by the user. The update will resume either due to a deselect condition or when the pointer increments to an Alarm or RAM address (08h to 3Fh).

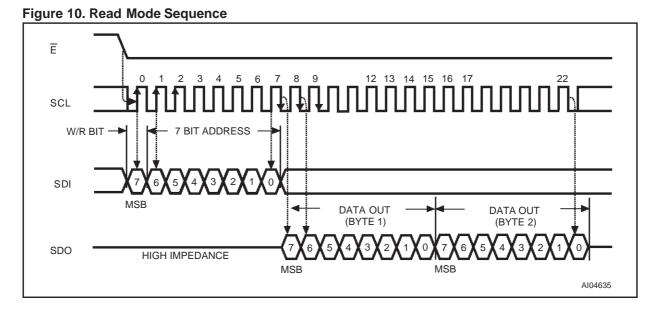
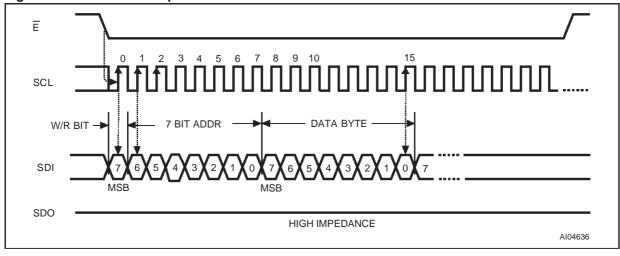


Figure 11. Write Mode Sequence

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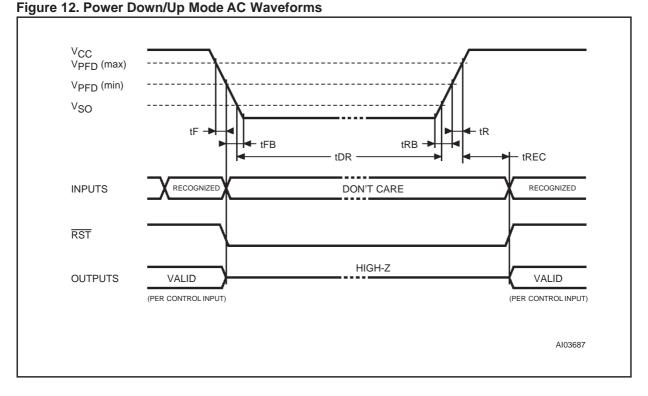
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## **Data Retention Mode**

With valid V<sub>CC</sub> applied, the M41T94 can be accessed as described above with read or write cycles. Should the supply voltage decay, the M41T94 will automatically deselect, write protecting itself when V<sub>CC</sub> falls between V<sub>PFD</sub> (max) and V<sub>PFD</sub> (min) (see Figure 12, page 14). At this time, the Reset pin (RST) is driven active and will remain active until V<sub>CC</sub> returns to nominal levels (see Figure 15, page 20). When V<sub>CC</sub> falls below the switch-over voltage (V<sub>SO</sub>), power input is switched from the V<sub>CC</sub> pin to the SNAPHAT bat-

tery (or external battery for SO16) and the clock registers are maintained from the attached battery supply. All outputs become high impedance. On power up, when  $V_{CC}$  returns to a nominal value, write protection continues for  $t_{REC}$  by internally inhibiting  $\overline{E}$ . The RST signal also remains active during this time (see Figure 12, page 14). Before the next active cycle, Chip Enable should be taken high for at least  $t_{EHEL}$ , then low.

For a further more detailed review of lifetime calculations, please see Application Note AN1012.



Symbol	Parameter	Min	Тур	Max	Unit
t <sub>F</sub> <sup>(1)</sup>	$V_{\text{PFD}}$ (max) to $V_{\text{PFD}}$ (min) $V_{\text{CC}}$ Fall Time	300			μs
t <sub>FB</sub> <sup>(2)</sup>	V <sub>PFD</sub> (min) to V <sub>SS</sub> V <sub>CC</sub> Fall Time	10			μs
t <sub>R</sub>	$V_{\text{PFD}}  (\text{min})$ to $ V_{\text{PFD}}  (\text{max})  V_{\text{CC}}  \text{Rise Time}$	10			μs
t <sub>RB</sub>	$V_{\mbox{\scriptsize SS}}$ to $V_{\mbox{\scriptsize PFD}}$ (min) $V_{\mbox{\scriptsize CC}}$ Rise Time	1			μs
trec	Power up Deselect Time	40		200	ms
tDR	Expected Data Retention Time	10 <sup>(3)</sup>			YEARS

Note: 1. V<sub>PFD</sub> (max) to V<sub>PFD</sub> (min) fall time of less than t<sub>F</sub> may result in deselection/write protection not occurring until 200µs after V<sub>CC</sub> passes V<sub>PFD</sub> (min).

2.  $V_{PFD}$  (min) to  $V_{SS}$  fall time of less than  $t_{FB}$  may cause corruption of RAM data.

3. At 25°C (when using SOH28 + M4T28-BR12SH SNAPHAT top).



#### **CLOCK OPERATIONS**

The eight byte clock register (see Table 9, page 16) is used to both set the clock and to read the date and time from the clock, in a binary coded decimal format. Tenths/Hundredths of Seconds, Seconds, Minutes, and Hours are contained within the first four registers. Bits D6 and D7 of clock register 3 (Century/Hours Register) contain the CEN-TURY ENABLE Bit (CEB) and the CENTURY Bit (CB). Setting CEB to a '1' will cause CB to toggle, either from '0' to '1' or from '1' to '0' at the turn of the century (depending upon its initial state). If CEB is set to a '0,' CB will not toggle. Bits D0 through D2 of register 4 contain the Day (day of week). Registers 5, 6 and 7 contain the Date (day of month), Month and Years. The ninth clock register is the Control Register (this is described in the Clock Calibration section). Bit D7 of register 1 contains the STOP Bit (ST). Setting this bit to a '1' will cause the oscillator to stop. If the device is expected to spend a significant amount of time on the shelf, the oscillator may be stopped to reduce current drain. When reset to a '0' the oscillator restarts within one second.

The eight Clock Registers may be read one byte at a time, or in a sequential block. The Control Register (Address location 08h) may be accessed independently. Provision has been made to assure that a clock update does not occur while any of the eight clock addresses are being read. If a clock address is being read, an update of the clock registers will be halted. This will prevent a transition of data during the read.

**Note:** Upon power-up following a power failure, the HT bit will automatically be set to a '1.' This will prevent the clock from updating the clock registers, and will allow the user to read the exact time of the power-down event. Resetting the HT bit to a '0' will allow the clock to update the clock registers with the current time.

### **TIMEKEEPER® Registers**

The M41T94 offers 20 internal registers which contain Clock, Alarm, Watchdog, Flag, Square Wave and Control data (see Table 9, page 16). These registers are memory locations which contain external (user accessible) and internal copies of the data (usually referred to as BiPORT<sup>TM</sup> TIMEKEEPER cells). The external copies are in-

dependent of internal functions except that they are updated periodically by the simultaneous transfer of the incremented internal copy. TIME-KEEPER and Alarm Registers store data in BCD. Control, Watchdog and Square Wave Registers store data in Binary format.

Table 9. TIMEKEEPER® Register Map

Addr									Function/I	
	D7	D6	D5	D4	D3	D2	D1	D0	BCD For	rmat
00h		0.1 Seconds			0.01 Seconds				Seconds	00-99
01h	ST	10 Seconds				Seco	onds		Seconds	00-59
02h	0	1	0 Minute	S		Min	utes		Minutes	00-59
03h	CEB	СВ	10 H	lours	Ho	ours (24 H	lour Form	at)	Century/Hour	0-1/00-23
04h	0	0	0	0	0	D	ay of Wee	ek	Day	01-7
05h	0	0	10 [	Date		Date: Day	of Month	1	Date	01-31
06h	0	0	0	10M		Мо	nth		Month	01-12
07h		10 Years				Ye	ar		Year	00-99
08h	OUT	FT	S		(	Calibratior	۱		Control	
09h	WDS	BMB4	BMB3	BMB2	BMB1	BMB0	RB1	RB0	Watchdog	
0Ah	AFE	SQWE	ABE	AI 10M		Alarm	Month		Al Month	01-12
0Bh	RPT4	RPT5	AI 10	Date		Alarm	Date		Al Date	01-31
0Ch	RPT3	HT	AI 10	Hour		Alarm	Hour		Al Hour	00-23
0Dh	RPT2	Alar	m 10 Min	utes		Alarm N	<b>Vinutes</b>		Al Min	00-59
0Eh	RPT1	Aları	m 10 Sec	onds		Alarm S	Seconds		Al Sec	00-59
0Fh	WDF	AF	0	BL	0	0	0	0	Flags	
10h	0	0	0	0	0	0	0	0	Reserved	
11h	0	0	0	0	0	0	0	0	Reserved	
12h	0	0	0	0	0	0	0	0	Reserved	
13h	RS3	RS2	RS1	RS0	0	0	0	0	SQW	

Keys: S = Sign Bit

FT = Frequency Test Bit

ST = Stop Bit

0 = Must be set to zero

BL = Battery Low Flag

BMB0-BMB4 = Watchdog Multiplier Bits

CEB = Century Enable Bit

CB = Century Bit

OUT = Output level AFE = Alarm Flag Enable Flag RB0-RB1 = Watchdog Resolution Bits

WDS = Watchdog Steering Bit

ABE = Alarm in Battery Back-Up Mode Enable Bit RPT1-RPT5 = Alarm Repeat Mode Bits WDF = Watchdog flag AF = Alarm flag SQWE = Square Wave Enable RS0-RS3 = SQW Frequency HT = Halt Update Bit



#### Setting Alarm Clock Registers

Address locations 0Ah-0Eh contain the alarm settings. The alarm can be configured to go off at a prescribed time on a specific month, date, hour, minute, or second or repeat every year, month, day, hour, minute, or second. It can also be programmed to go off while the M41T94 is in the battery back-up to serve as a system wake-up call.

Bits RPT5-RPT1 put the alarm in the repeat mode of operation. Table 10, page 17 shows the possible configurations. Codes not listed in the table default to the once per second mode to quickly alert the user of an incorrect alarm setting.

When the clock information matches the alarm clock settings based on the match criteria defined by RPT5-RPT1, the AF (Alarm Flag) is set. If AFE (Alarm Flag Enable) is also set, the alarm condition activates the IRQ/FT/OUT pin. To disable

alarm, write '0' to the Alarm Date Register and to RPT1–5. The IRQ/FT/OUT output is cleared by a read to the Flags register. This read of the Flags register will also reset the Alarm Flag (D6; Register 0Fh). See Figure 13, page 17.

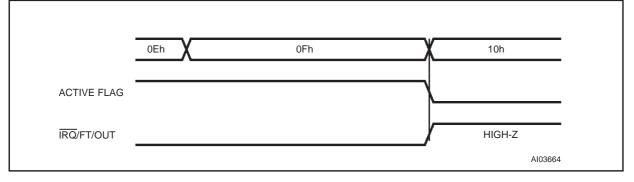
The IRQ/FT/OUT pin can also be activated in the battery back-up mode. The IRQ/FT/OUT will go low if an alarm occurs and both ABE (Alarm in Battery Back-up Mode Enable) and AFE are set. The ABE and AFE bits are reset during power-up, therefore an alarm generated during power-up will only set AF. The user can read the Flag Register at system boot-up to determine if an alarm was generated while the M41T94 was in the deselect mode during power-up. Figure 14, page 18 illustrates the back-up mode alarm timing.

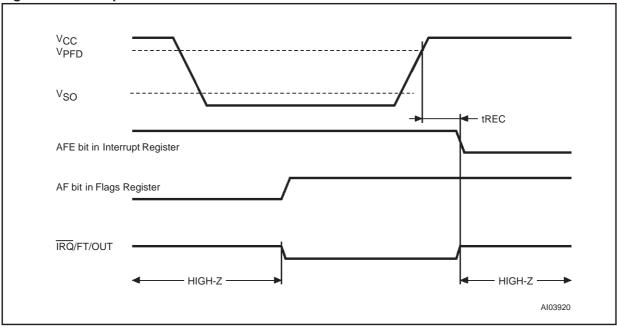
Table	10.	Alarm	Repeat	Mode
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RPT5	RPT4	RPT3	RPT2	RPT1	Alarm Setting
1	1	1	1	1	Once per Second
1	1	1	1	0	Once per Minute
1	1	1	0	0	Once per Hour
1	1	0	0	0	Once per Day
1	0	0	0	0	Once per Month
0	0	0	0	0	Once per Year

#### Figure 13. Alarm Interrupt Reset Waveforms





## Figure 14. Back-up Mode Alarm Waveforms

## Watchdog Timer

The watchdog timer can be used to detect an outof-control microprocessor. The user programs the watchdog timer by setting the desired amount of time-out into the Watchdog Register, address 09h. Bits BMB4-BMB0 store a binary multiplier and the two lower order bits RB1-RB0 select the resolution, where  $00 = \frac{1}{16}$  second,  $01 = \frac{1}{4}$  second, 10 = 1 second, and 11 = 4 seconds. The amount of time-out is then determined to be the multiplication of the five bit multiplier value with the resolution. (For example: writing 00001110 in the Watchdog Register = 3\*1 or 3 seconds).

Note: Accuracy of timer is within  $\pm$  the selected resolution.

If the processor does not reset the timer within the specified period, the M41T94 sets the WDF (Watchdog Flag) and generates a watchdog interrupt or a microprocessor reset. WDF is reset by reading the Flags Register (0Fh).

The most significant bit of the Watchdog Register is the Watchdog Steering Bit (WDS). When set to a '0', the watchdog will activate the IRQ/FT/OUT pin when timed-out. When WDS is set to a '1', the watchdog will output a negative pulse on the RST pin for  $t_{REC}$ . The Watchdog register and the FT bit will reset to a '0' at the end of a Watchdog time-out when the WDS bit is set to a '1.'

The watchdog timer can be reset by two methods:

a transition (high-to-low or low-to-high) can be applied to the Watchdog Input pin (WDI) or

the microprocessor can perform a write of the Watchdog Register.

The time-out period then starts over. The WDI pin should be tied to  $V_{SS}$  if not used. In order to perform a software reset of the watchdog timer, the original time-out period can be written into the Watchdog Register, effectively restarting the count-down cycle.

Should the watchdog timer time-out, and the WDS bit is programmed to output an interrupt, a value of 00h needs to be written to the Watchdog Register in order to clear the IRQ/FT/OUT pin. This will also disable the watchdog function until it is again programmed correctly. A read of the Flags Register will reset the Watchdog Flag (Bit D7; Register 0Fh).

The watchdog function is automatically disabled upon power-up and the Watchdog Register is cleared. If the watchdog function is set to output to the IRQ/FT/OUT pin and the frequency test function is activated, the watchdog function prevails and the frequency test function is denied. The OUT function has the lowest priority and will only be enabled when the Watchdog Register (09h), AFE Bit and FT Bit are '0.'

## **Square Wave Output**

The M41T94 offers the user a programmable square wave function which is output on the SQW pin. RS3-RS0 bits located in 13h establish the square wave output frequency. These frequencies

are listed in Table 11. Once the selection of the SQW frequency has been completed, the SQW pin can be turned on and off under software control with the Square Wave Enable Bit (SQWE) located in Register 0Ah.

	Square V	Square	e Wave		
RS3	RS2	RS1	RS0	Frequency	Units
0	0	0	0	None	-
0	0	0	1	32.768	kHz
0	0	1	0	8.192	kHz
0	0	1	1	4.096	kHz
0	1	0	0	2.048	kHz
0	1	0	1	1.024	kHz
0	1	1	0	512	Hz
0	1	1	1	256	Hz
1	0	0	0	128	Hz
1	0	0	1	64	Hz
1	0	1	0	32	Hz
1	0	1	1	16	Hz
1	1	0	0	8	Hz
1	1	0	1	4	Hz
1	1	1	0	2	Hz
1	1	1	1	1	Hz

Table 11. Square Wave Output Frequency

## **Power-on Reset**

The M41T94 continuously monitors V<sub>CC</sub>. When V<sub>CC</sub> falls to the power fail detect trip point, the RST pulls low (open drain) and remains low on powerup for t<sub>REC</sub> after V<sub>CC</sub> passes V<sub>PFD</sub>. The RST pin is an open drain output and an appropriate pull-up resistor should be chosen to control rise time.

# Reset Inputs (RSTIN1 & RSTIN2)

The M41T94 provides two independent inputs which can generate an output reset. The duration and function of these resets is identical to a reset generated by a power cycle. Table 12, page 20 and Figure 15, page 20 illustrate the AC reset characteristics of this function. Pulses shorter than  $\underline{t_{R1}}$  and  $\underline{t_{R2}}$  will not generate a reset condition. RSTIN1 and RSTIN2 are each internally pulled up to  $V_{CC}$  through a 100k $\Omega$  resistor.

# Figure 15. RSTIN1 and RSTIN2 Timing Waveforms

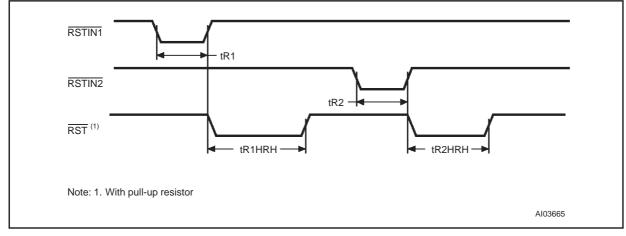


Table 12. Reset AC C	haracteristics
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Symbol	Parameter	Min	Мах	Unit
t <sub>R1</sub> <sup>(1)</sup>	RSTIN1 Low to RSTIN1 High	200		ns
t <sub>R2</sub> <sup>(2)</sup>	RSTIN2 Low to RSTIN2 High	100		ms
t <sub>R1HRH</sub> <sup>(3)</sup>	RSTIN1 High to RST High	40	200	ms
t <sub>R2HRH</sub> <sup>(3)</sup>	RSTIN2 High to RST High	40	200	ms

Note: 1. Pulse width less than 50ns will result in no RESET (for noise immunity).

2. Pulse width less than 20ms will result in no RESET (for noise immunity).

3.  $C_L = 100 pF$  (see Table 4, page 8).



## **Calibrating the Clock**

The M41T94 is driven by a quartz controlled oscillator with a nominal frequency of 32,768 Hz. Uncalibrated clock accuracy will not exceed  $\pm$ 35 PPM (parts per million) oscillator frequency error at 25°C, which equates to about  $\pm$ 1.53 minutes per month. When the Calibration circuit is properly employed, accuracy improves to better than +1/–2 PPM at 25°C.

The oscillation rate of crystals changes with temperature (see Figure 16, page 22). Therefore, the M41T94 design employs periodic counter correction. The calibration circuit adds or subtracts counts from the oscillator divider circuit at the divide by 256 stage, as shown in Figure 17, page 22. The number of times pulses which are blanked (subtracted, negative calibration) or split (added, positive calibration) depends upon the value loaded into the five Calibration bits found in the Control Register. Adding counts speeds the clock up, subtracting counts slows the clock down.

The Calibration bits occupy the five lower order bits (D4-D0) in the Control Register (8h). These bits can be set to represent any value between 0 and 31 in binary form. Bit D5 is a Sign bit; '1' indicates positive calibration, '0' indicates negative calibration. Calibration occurs within a 64 minute cycle. The first 62 minutes in the cycle may, once per minute, have one second either shortened by 128 or lengthened by 256 oscillator cycles. If a binary '1' is loaded into the register, only the first 2 minutes in the 64 minute cycle will be modified; if a binary 6 is loaded, the first 12 will be affected, and so on.

Therefore, each calibration step has the effect of adding 512 or subtracting 256 oscillator cycles for every 125,829,120 actual oscillator cycles, that is +4.068 or -2.034 PPM of adjustment per calibration step in the calibration register. Assuming that the oscillator is running at exactly 32,768 Hz, each of the 31 increments in the Calibration byte would represent +10.7 or -5.35 seconds per month which corresponds to a total range of +5.5 or -2.75 minutes per month.

Two methods are available for ascertaining how much calibration a given M41T94 may require.

The first involves setting the clock, letting it run for a month and comparing it to a known accurate reference and recording deviation over a fixed period of time. Calibration values, including the number of seconds lost or gained in a given period, can be found in Application Note AN934: TIMEKEEPER CALIBRATION. This allows the designer to give the end user the ability to calibrate the clock as the environment requires, even if the final product is packaged in a non-user serviceable enclosure. The designer could provide a simple utility that accesses the Calibration byte. The second approach is better suited to a manufacturing environment, and involves the use of the IRQ/FT/OUT pin. The pin will toggle at 512Hz, when the Stop bit (ST, D7 of 1h) is '0', the Frequency Test bit (FT, D6 of 8h) is '1', the Alarm Flag Enable bit (AFE, D7 of Ah) is '0', and the Watchdog Steering bit (WDS, D7 of 9h) is '1' or the Watchdog Register (9h = 0) is reset.

Any deviation from 512 Hz indicates the degree and direction of oscillator frequency shift at the test temperature. For example, a reading of 512.010124 Hz would indicate a +20 PPM oscillator frequency error, requiring a -10 (XX001010) to be loaded into the Calibration Byte for correction. Note that setting or changing the Calibration Byte does not affect the Frequency test output frequency.

The  $\overline{IRQ}/FT/OUT$  pin is an open drain output which requires a pull-up resistor for proper operation. A 500 to  $10k\Omega$  resistor is recommended in order to control the rise time. The FT bit is cleared on power-down.

#### **Century Bit**

Bits D7 and D6 of Clock Register 03h contain the CENTURY ENABLE Bit (CEB) and the CENTURY Bit (CB). Setting CEB to a '1' will cause CB to toggle, either from a '0' to '1' or from '1' to '0' at the turn of the century (depending upon its initial state). If CEB is set to a '0', CB will not toggle.

#### **Output Driver Pin**

When the FT bit, AFE bit and watchdog register are not set, the IRQ/FT/OUT pin becomes an output driver that reflects the contents of D7 of the Control Register. In other words, when D6 of location 08h is a '0', D7 of location 08h and 0Ah and the watchdog register are a '0' then the IRQ/FT/ OUT pin will be driven low.

**Note:** The IRQ/FT/OUT pin is an open drain which requires an external pull-up resistor.

#### Battery Low Warning

The M41T94 automatically performs battery voltage monitoring upon power-up and at factory-programmed time intervals of approximately 24 hours. The Battery Low (BL) bit, Bit D4 of Flags Register 0Fh, will be asserted if the battery voltage is found to be less than approximately 2.5V. The BL bit will remain asserted until completion of battery replacement and subsequent battery low monitoring tests, either during the next power-up sequence or the next scheduled 24-hour interval.

If a battery low is generated during a power-up sequence, this indicates that the battery is below approximately 2.5 volts and may not be able to maintain data integrity in the SRAM. Data should



be considered suspect and verified as correct. A fresh battery should be installed.

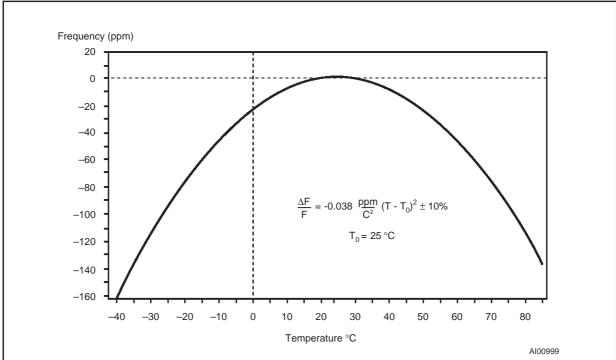
If a battery low indication is generated during the 24-hour interval check, this indicates that the battery is near end of life. However, data is not compromised due to the fact that a nominal  $V_{CC}$  is supplied. In order to insure data integrity during subsequent periods of battery back-up mode, the battery should be replaced. The SNAPHAT top may be replaced while  $V_{CC}$  is applied to the device.

**Note**: This will cause the clock to lose time during the interval the SNAPHAT battery/crystal top is disconnected.

The M41T94 only monitors the battery when a nominal  $V_{CC}$  is applied to the device. Thus applications which require extensive durations in the battery back-up mode should be powered-up periodically (at least once every few months) in order for this technique to be beneficial. Additionally, if a battery low is indicated, data integrity should be verified upon power-up via a checksum or other technique.

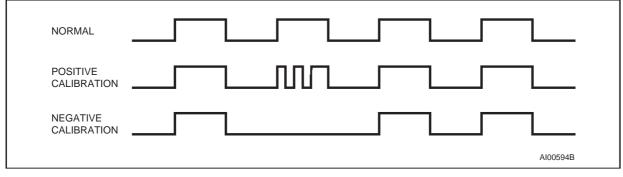
#### **Initial Power-on Defaults**

Upon initial application of power to the device, the following register bits are set to a '0' state: Watchdog Register; FT; AFE; ABE and SQWE. The following bits are set to a '1' state: ST; OUT; and HT.









#### PART NUMBERING

## Table 13. Ordering Information Scheme

Example:	M41T	94	МН	6	TR
Device Type					
M41T					
Supply Voltage and Write Protect Voltage					
$94 = V_{CC} = 2.7V$ to $5.5V$					
THS = V_{CC}; V_{PFD} = 4.40 $\pm$ 0.10V					
THS = V_{SS}; V_{PFD} = 2.65 $\pm$ 0.05V					
Package					
MQ = SO16					
MH <sup>(1)</sup> = SOH28					
Temperature Range					
6 = −40 to 85 °C					
Shipping Method for SOIC					

blank = Tubes

TR = Tape & Reel

Note: 1. The 28-pin SOIC package (SOH28) requires the battery/crystal package (SNAPHAT) which is ordered separately under the part number "M4TXX-BR12SHX" in plastic tube or "M4TXX-BR12SHXTR" in Tape & Reel form.

Caution:Do NOT place the SNAPHAT battery package "M4TXX-BR12SH" in conductive foam since will drain the lithium button-cell battery.

For a list of available options (e.g., Speed, Package) or for further information on any aspect of this device, please contact the ST Sales Office nearest to you.

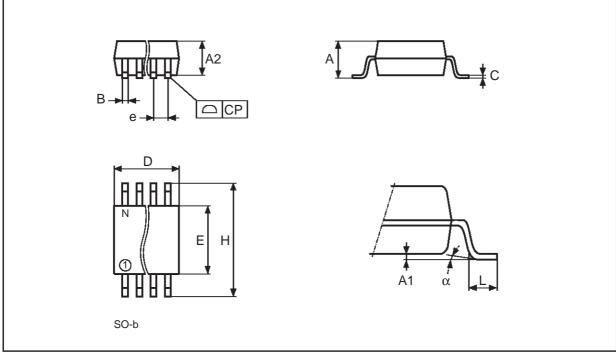
## Table 14. SNAPHAT Battery Table

Part Number	Description	Package
M4T28-BR12SH	Lithium Battery (48mAh) and Crystal SNAPHAT	SH
M4T32-BR12SH	Lithium Battery (120mAh) and Crystal SNAPHAT	SH

# M41T94

# PACKAGE MECHANICAL INFORMATION

# Figure 18. SO16 - 16 lead Plastic Small Outline Package Outline



Note: Drawing is not to scale.

Symbol		millimeters			inches	
Symbol	Тур.	Min.	Max.	Тур.	Min.	Max.
А			1.75			0.069
A1		0.10	0.25		0.004	0.010
A2			1.60			0.063
В		0.35	0.46		0.014	0.018
С		0.19	0.25		0.007	0.010
D		9.80	10.00		0.386	0.394
E		3.80	4.00		0.150	0.158
е	1.27	-	-	0.050	_	-
Н		5.80	6.20		0.228	0.244
L		0.40	1.27		0.016	0.050
а		0°	8°		0°	8°
Ν		16			16	
CP			0.10			0.004

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## Table 15. SO16 - 16 lead Plastic Small Outline Package Mechanical Data

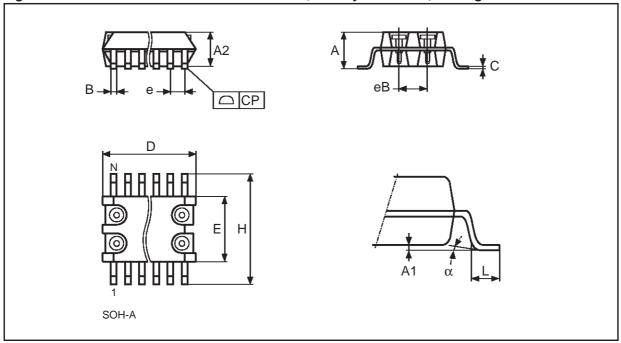


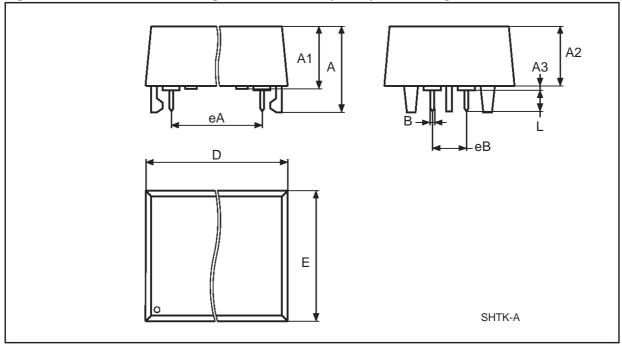
Figure 19. SOH28 - 28 lead Plastic Small Outline, Battery SNAPHAT, Package Outline

Note: Drawing is not to scale.

## Table 16. SOH28 - 28 lead Plastic Small Outline, battery SNAPHAT, Package Mechanical Data

Symbol		millimeters			inches	
Symbol	Тур	Min	Max	Тур	Min	Max
А			3.05			0.120
A1		0.05	0.36		0.002	0.014
A2		2.34	2.69		0.092	0.106
В		0.36	0.51		0.014	0.020
С		0.15	0.32		0.006	0.012
D		17.71	18.49		0.697	0.728
E		8.23	8.89		0.324	0.350
е	1.27	-	-	0.050	-	-
eB		3.20	3.61		0.126	0.142
Н		11.51	12.70		0.453	0.500
L		0.41	1.27		0.016	0.050
α		0°	8°		0°	8°
Ν		28	•		28	•
CP			0.10			0.004

# M41T94

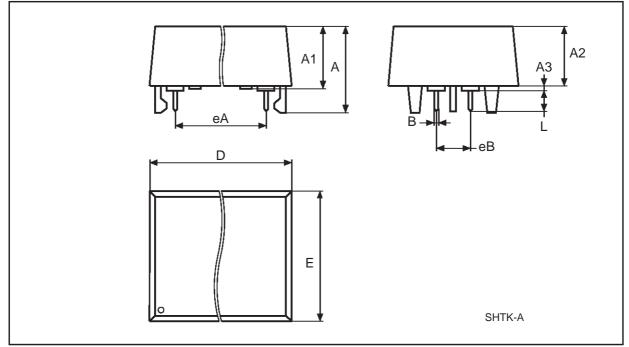


# Figure 20. SH - SNAPHAT Housing for 48 mAh Battery & Crystal, Package Outline

Note: Drawing is not to scale.

# Table 17. SH - SNAPHAT Housing for 48 mAh Battery & Crystal, Package Mechanical Data

Symbol	millimeters				inches	
Symbol	Тур	Min	Мах	Тур	Min	Max
A			9.78			0.3850
A1		6.73	7.24		0.2650	0.2850
A2		6.48	6.99		0.2551	0.2752
A3			0.38			0.0150
В		0.46	0.56		0.0181	0.0220
D		21.21	21.84		0.8350	0.8598
E		14.22	14.99		0.5598	0.5902
eA		15.55	15.95		0.6122	0.6280
eB		3.20	3.61		0.1260	0.1421
L		2.03	2.29		0.0799	0.0902



# Figure 21. SH - SNAPHAT Housing for 120 mAh Battery & Crystal, Package Outline

Note: Drawing is not to scale.

# Table 18. SH - SNAPHAT Housing for 120 mAh Battery & Crystal, Package Mechanical Data

Symbol	millimeters			inches		
Symbol	Тур	Min	Мах	Тур	Min	Мах
A			10.54			0.4150
A1		6.73	7.24		0.2650	0.2850
A2		6.48	6.99		0.2551	0.2752
A3			0.38			0.0150
В		0.46	0.56		0.0181	0.0220
D		21.21	21.84		0.8350	0.8598
E		14.22	14.99		0.5598	0.5902
eA		15.55	15.95		0.6122	0.6280
eB		3.20	3.61		0.1260	0.1421
L		2.03	2.29		0.0799	0.0902

## **REVISION HISTORY**

## Table 19. Document Revision History

Date	Revision Details		
October 2000	First draft		
09/22/00	SO16 package measures change		
12/24/00	Reformatted; added/altered graphics (Figures 5, 6, 8, 9, 10, 11); altered tables (Tables 2, 7, 6)		



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